

## 1A, 200V - 600V Surface Mount Ultrafast Rectifiers

### FEATURES

- Very low profile - typical height of 0.68mm
- Reduce switching and conduction loss
- Ideal for automated placement
- Ultrafast recovery times for high frequency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21



Micro SMA



### APPLICATION

ESH1DM to ESH1JM is ideal device for the compact space PCB design.

Specially as boost diode in power factor correction circuitry.

The device is also intended for use as a free wheeling diode in power supplies

For chargers, LED lighting, and other power switching applications.

### MECHANICAL DATA

**Case:** Micro SMA

Molding compound: UL flammability classification rating 94V-0

Moisture sensitivity level: level 1, per J-STD-020

Part no. with suffix "H" means AEC-Q101 qualified

Packing code with suffix "G" means green compound (halogen-free)

**Terminal:** Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 2 whisker test

**Polarity:** Indicated by cathode band

**Weight:** 6mg (approximately)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T <sub>A</sub> =25°C unless otherwise noted)					
PARAMETER	SYMBOL	ESH1DM	ESH1GM	ESH1JM	UNIT
Marking code		D3	D5	D7	
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	200	400	600	V
Maximum average forward rectified current	I <sub>F(AV)</sub>	1			A
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	15			A
Maximum instantaneous forward voltage (Note 1) @ 1 A	V <sub>F</sub>	TYP		MAX	V
		1.25		1.5	
Maximum reverse current @ rated VR T <sub>J</sub> =25 °C T <sub>J</sub> =125 °C	I <sub>R</sub>	TYP		MAX	μA
		-		1	
		5		50	
Maximum reverse recovery time (Note 2)	t <sub>rr</sub>	25			ns
Typical junction capacitance (Note 3)	C <sub>J</sub>	3			pF
Typical thermal resistance (Note 4)	R <sub>θJM</sub>	40			°C/W
	R <sub>θJA</sub>	92			
Operating junction temperature range	T <sub>J</sub>	-55 to +150			°C
Storage temperature range	T <sub>STG</sub>	-55 to +150			°C

Note 1: Pulse test with PW=300μs, 1% duty cycle

Note 2: Test conditions: I<sub>F</sub>=0.5A, I<sub>R</sub>=1.0A, I<sub>RR</sub>=0.25A

Note 3: Measured at 1 MHz and applied reverse voltage of 4.0 V

Note 4: Thermal resistance R<sub>θJA</sub> - from junction to ambient, R<sub>θJM</sub> - and junction to mount

ORDERING INFORMATION					
PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING
ESH1xM (Note 1, 2)	H	RS	G	Micro SMA	3,000 / 7" Plastic reel

Note 1: "x" defines voltage from 200V (ESH1DM) to 600V (ESH1JM)

Note 2: Whole series with green compound

EXAMPLE					
EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
ESH1JMHRSG	ESH1JM	H	RS	G	Automotive grade Green compound

**RATINGS AND CHARACTERISTICS CURVES**

(T<sub>A</sub>=25°C unless otherwise noted)

FIG.1 MAXIMUM FORWARD CURRENT DERATING CURVE

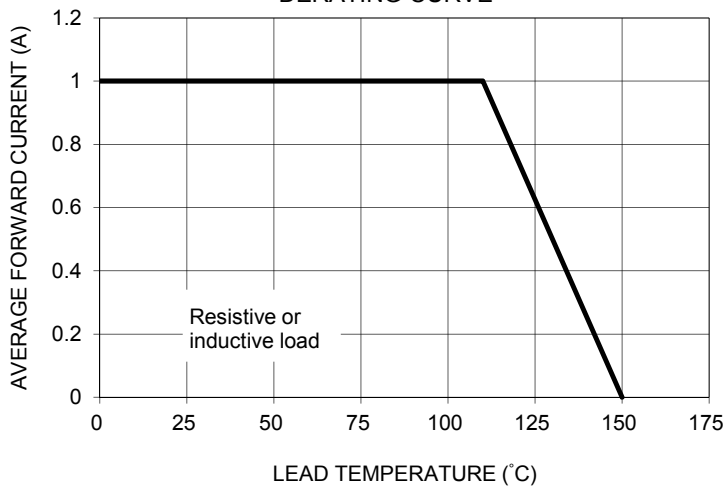


FIG. 2 MAXIMUM FORWARD SURGE CURRENT

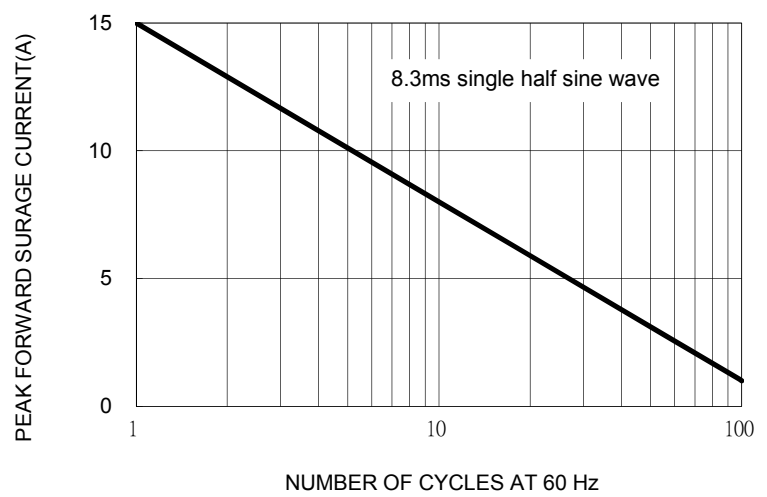


FIG. 3 TYPICAL FORWARD CHARACTERISTICS

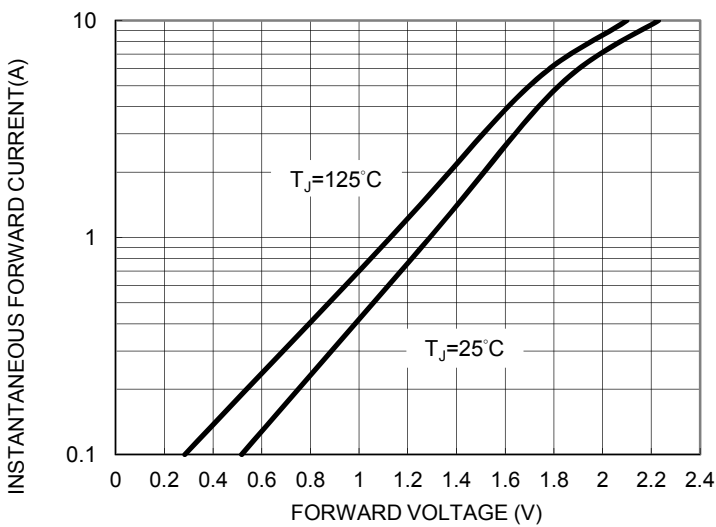
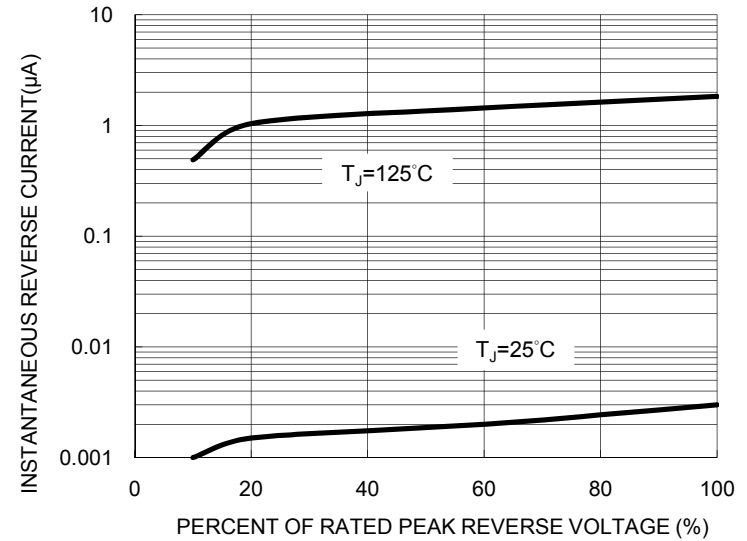
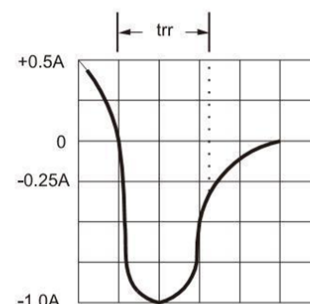
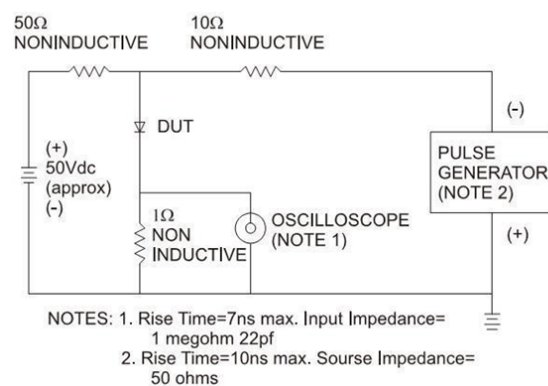


FIG. 4 TYPICAL REVERSE CHARACTERISTICS

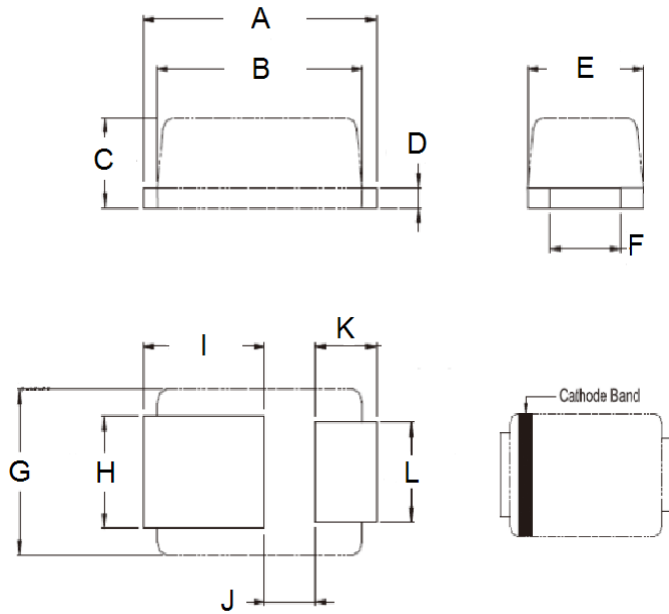


**REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM**



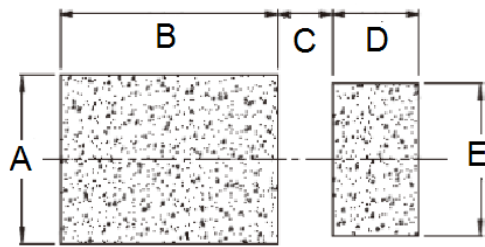
PACKAGE OUTLINE DIMENSIONS

**Micro SMA**



DIM.	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	2.30	2.70	0.091	0.106
B	2.10	2.30	0.083	0.091
C	0.63	0.73	0.025	0.029
D	0.10	0.20	0.004	0.008
E	1.15	1.35	0.045	0.053
F	0.65	0.85	0.026	0.034
G	1.15	1.35	0.045	0.053
H	0.75	0.95	0.030	0.037
I	1.10	1.50	0.043	0.059
J	0.55	0.75	0.022	0.030
K	0.55	0.75	0.022	0.030
L	0.65	0.85	0.026	0.034

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.1	0.043
B	2.0	0.079
C	0.5	0.020
D	0.8	0.031
E	1.0	0.039

MARKING DIAGRAM



P/N = Marking code  
YW = Date Code

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Version: C1602